

Features

- ♦ Zener voltage range 2.0 to 75 volts
- ♦ Surface device type mounting
- Hermetically sealed glass
- ♦ Compression Bonded Construction
- All external surfaces are corrosion resistant and terminals are readily solderable
- ♦ RoHS compliant
- ♦ Matte Tin(Sn) lead finish
- Blue color band indicates negative polarity



LL-34

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Type Number	Symbol	Value	Units
Power Dissipation	Ptot	500	mW
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to + 200	°C

Notes: These ratings are limiting values above which the serviceability of the diode may be impaired

ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Type Number	V _z	DI _{ZT}	I _{ZT} mA	Z _{ZT} @ I _{ZT} Ohms Max	I _{ZK} mA	Z _{ZK} @ I _{ZK} Ohms	IR @ VR uA Max	VR V
BZV55-B15,115-JSM	Min (V) 5.00	Max (V) 5.2	5	35	1.0	550	0.1	0.1
VF Forward Voltage = 1.0v Maximum @ IF=100mA for all types								

Notes: 1. The type numbers listed have zener voltage min/max limits as shown.

2. The zener impedance is derived from the 60-cycle ac voltage, which results when an ac current having an rms value equal to 10% of the dc zener current (Izτ or Izκ) is superimposed to Izτor Izκ.

RATINGS AND CHARACTERISTIC CURVES (BZV55B SERIES)

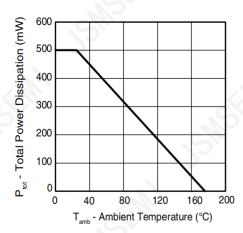


Figure 1. Total Power Dissipation vs. Ambient Temperature

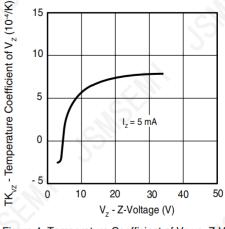


Figure 4. Temperature Coefficient of Vz vs. Z-Voltage

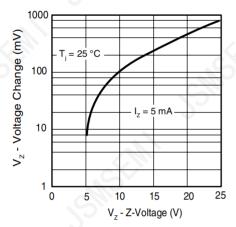


Figure 2. Typical Change of Working Voltage under Operating Conditions at T_{amb} =25°C

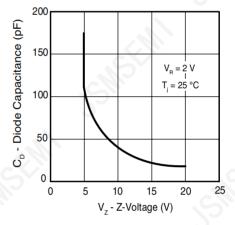


Figure 5. Diode Capacitance vs. Z-Voltage

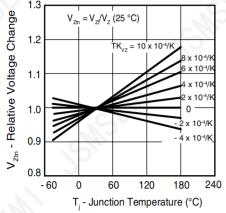


Figure 3. Typical Change of Working Voltage vs. Junction Temperature

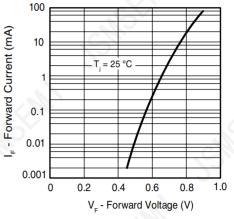


Figure 6. Forward Current vs. Forward Voltage

RATINGS AND CHARACTERISTIC CURVES (BZV55B SERIES)

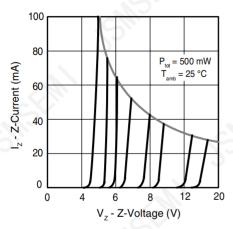


Figure 7. Z-Current vs. Z-Voltage

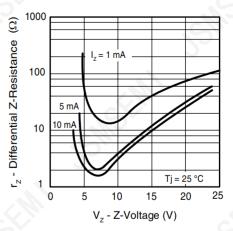


Figure 9. Differential Z-Resistance vs. Z-Voltage

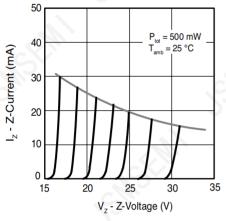


Figure 8. Z-Current vs. Z-Voltage

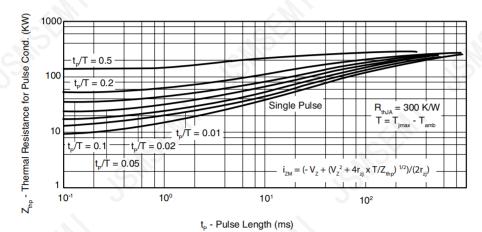
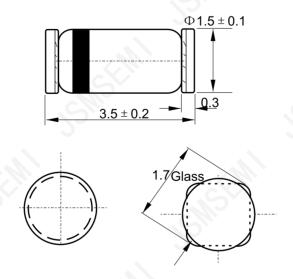


Figure 10. Thermal Response



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Dimension in millimeters



Revision History

Rev.	Change	Date
V1.0	Initial version	2/23/2024

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